LB G6SP

Advanced Power TOPLED®

Advanced Power TOPLED features a compact package with a wide brightness range and high luminous efficiency.





Applications

- Custom Tuning
- Displays (Backlighting)

- Interior Illumination (e.g. Ambient Map)

Features:

- Package: white SMT package, colorless clear silicone resin
- Chip technology: ThinGaN
- Typ. Radiation: 120° (Lambertian emitter)
- − Color: λ_{dom} = 470 nm (• blue)
- Optical efficacy: 10 lm/W
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified with RV-level 1
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)



Ordering Information		
Туре	Luminous Intensity ¹⁾ I _F = 140 mA I _v	Ordering Code
LB G6SP-BACB-35-47	1.8 4.5 cd	Q65111A8888



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min. max.	-40 °C 110 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 110 °C
Junction Temperature	T _j	max.	125 °C
Junction Temperature for short time applications*	T _j	max.	150 °C
Forward current T _S = 25 °C	I _F	min. max.	30 mA 250 mA
Surge Current t \leq 10 μ s; D = 0.005 ; T _s = 25 °C	I _{FS}	max.	750 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV
Reverse current 2)	I _R	max.	200 mA

^{*} The median lifetime (L70/B50) for Tj = 150 $^{\circ}$ C is 100h.



LB G6SP

Characteristics

 I_F = 140 mA; T_S = 25 °C

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{\sf peak}$	typ.	465 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	464 nm
$I_F = 140 \text{ mA}$	40	typ.	470 nm
		max.	476 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	25 nm
Viewing angle at 50% I _v	2φ	typ.	120 °
Forward Voltage 4)	V _F	min.	2.90 V
$I_F = 140 \text{ mA}$	·	typ.	3.30 V
		max.	4.10 V
Reverse voltage (ESD device)	V _{R ESD}	min.	45 V
Reverse voltage 2)	V_R	max.	1.2 V
$I_R = 20 \text{ mA}$			
Real thermal resistance junction/solderpoint 5)	R _{thJS real}	typ.	35 K / W
	thoo real	max.	40 K / W
Electrical thermal resistance junction/solderpoint 5)	R _{thJS elec.}	typ.	29 K / W
with efficiency η_e = 17 %	1100 0100.	max.	33 K / W



Brightness Groups

Group	Luminous Intensity ¹⁾ $I_F = 140 \text{ mA}$ min. I_V	Luminous Intensity. 1) I _F = 140 mA max. I _v	Luminous Flux $^{6)}$ I _F = 140 mA typ. Φ_{V}
ВА	1.8 cd	2.2 cd	6.2 lm
ВВ	2.2 cd	2.8 cd	7.8 lm
CA	2.8 cd	3.6 cd	10.0 lm
СВ	3.6 cd	4.5 cd	12.6 lm

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 140 mA min. V _F	Forward Voltage ⁴⁾ I _F = 140 mA max. V _F
4	2.90 V	3.20 V
5	3.20 V	3.50 V
6	3.50 V	3.80 V
7	3.80 V	4.10 V

Wavelength Groups

Group	Dominant Wavelength ³⁾ I _F = 140 mA	Dominant Wavelength ³⁾ I _E = 140 mA
	min.	max.
	$\lambda_{\sf dom}$	$\lambda_{\sf dom}$
3	464 nm	468 nm
4	468 nm	472 nm
5	472 nm	476 nm



Group Name on Label

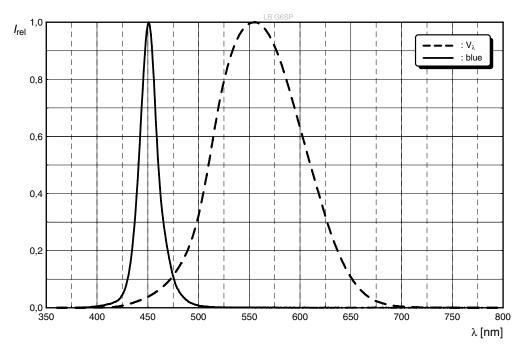
Example: BA-3-4

Brightness	Wavelength	Forward Voltage
BA	3	4



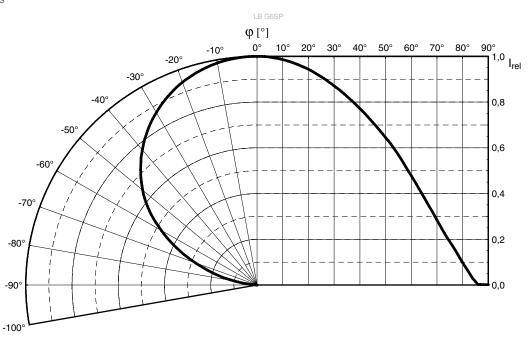
Relative Spectral Emission 6)

$$\Phi_{rel}$$
 = f (λ); I $_F$ = 140 mA; T $_S$ = 25 °C



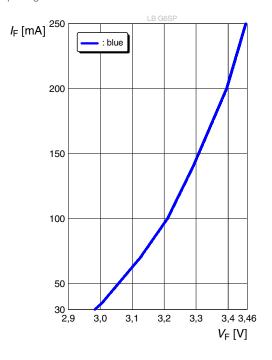
Radiation Characteristics 6)

$$I_{rel} = f(\phi); T_S = 25 \, ^{\circ}C$$



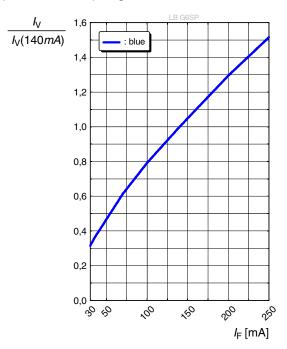
Forward current 6), 7)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



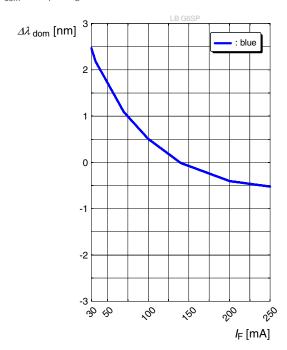
Relative Luminous Intensity 6), 7)

$$I_{v}/I_{v}(140 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$



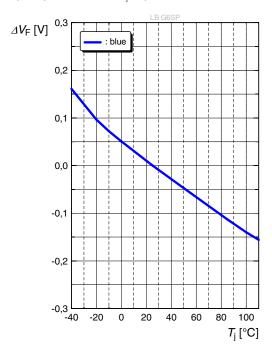
Dominant Wavelength 6)

$$\Delta\lambda_{dom} = f(I_F); T_S = 25 \text{ }^{\circ}\text{C}$$



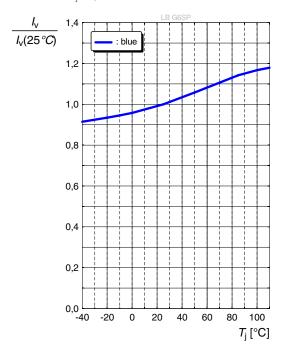
Forward Voltage 6)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25 \ ^{\circ}C) = f(T_{_j}); \ I_{_F} = 140 \ mA$$



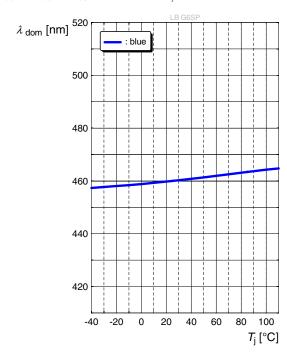
Relative Luminous Intensity 6)

$$I_{v}/I_{v}(25 \text{ °C}) = f(T_{j}); I_{F} = 140 \text{ mA}$$



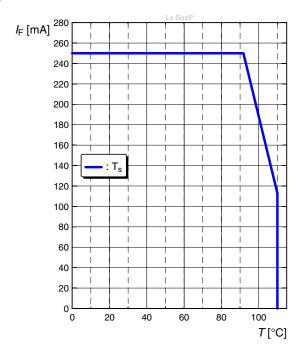
Dominant Wavelength 6)

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom} (25 \, ^{\circ}\text{C}) = f(T_j); I_F = 140 \, \text{mA}$$



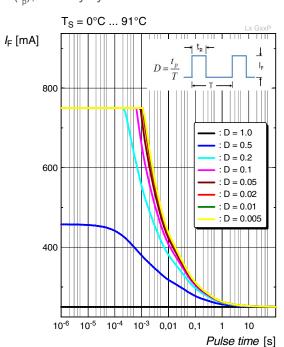
Max. Permissible Forward Current

 $I_F = f(T)$



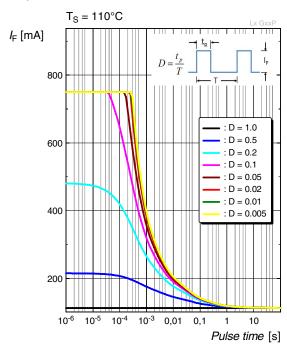
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle

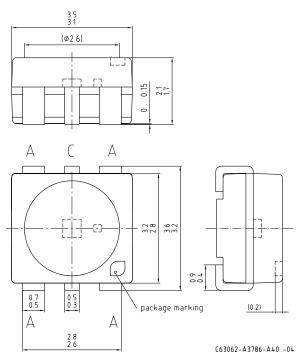


Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle



Dimensional Drawing 8)



Further Information:

Approximate Weight: 40.0 mg

Package marking: Anode

Corrosion test: Class: 3B

Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

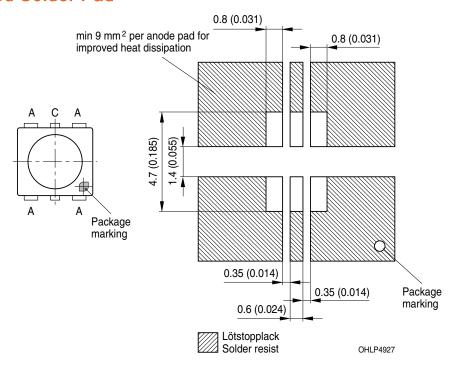
60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the

Chip.



Recommended Solder Pad 8)

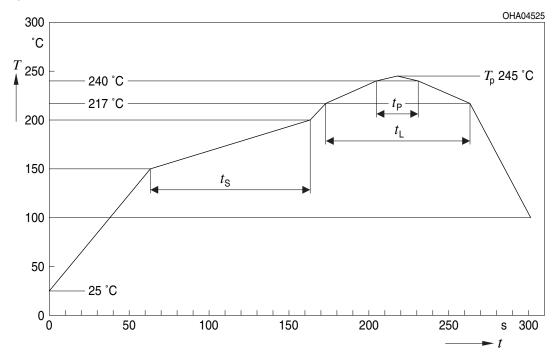


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)			2	3	K/s
25 °C to 150 °C					
Time t _s	t_s	60	100	120	S
T_{Smin} to T_{Smax}					
Ramp-up rate to peak*)			2	3	K/s
T_{Smax} to T_{P}					
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	T_{P}		245	260	°C
Time within 5 °C of the specified peak	t _P	10	20	30	S
temperature T _P - 5 K					
Ramp-down rate*			3	6	K/s
T _P to 100 °C					
Time				480	S
25 °C to T _P					

All temperatures refer to the center of the package, measured on the top of the component

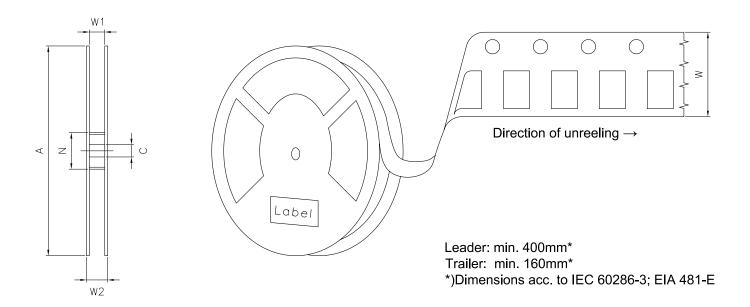


 $^{^{\}ast}$ slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping 8) 4 [0.157"] 1.75 [0.069"] 2 [0.079"] 0.3 [0.012"] 5.5 [0.217"] 1.5 [0.059"] 3.7 [0.146"] \bigoplus \bigoplus \bigoplus \bigoplus 12 [0.472"] cathode side 3.5 [0.138"] 2.05 [0.081"] 8 [0.315"]

C63062-A3786-B9 -03

Tape and Reel 9)



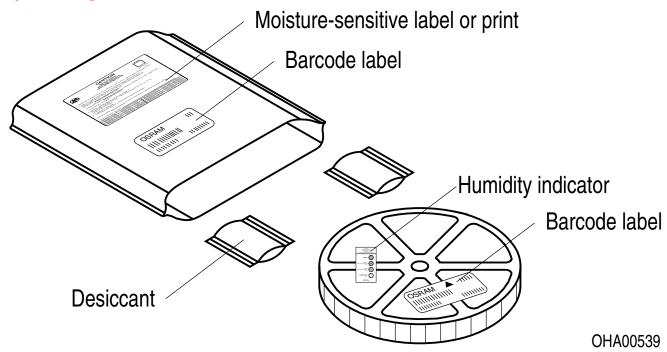
Reel Dimensions

Α	W	N_{\min}	W_1	$W_{2 \text{max}}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	1000

Barcode-Product-Label (BPL)



Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class moderate risk (exposure time 0.25 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k =
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 5) **Thermal Resistance:** Rth max is based on statistic values (6σ).
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 9) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



LB G6SP

Revision History				
Version	Date	Change		
1.5	2020-06-29	Features Maximum Ratings Characteristics Schematic Transportation Box Dimensions of Transportation Box Notes Disclaimer Glossary		



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